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## **Electrical ratings** 1

Table 2.	Absolute maximum ratings		
Symbol	Parameter	Value	Unit
V <sub>CER</sub>	Collector-emitter voltage ( $R_{BE} \le 10 \Omega$ )	1000	V
V <sub>CES</sub>	Collector-emitter voltage (V <sub>BE</sub> = 0)	1000	V
V <sub>CEO</sub>	Collector-emitter voltage $(I_B = 0)$	450	V
V <sub>EBO</sub>	Emitter-base voltage ( $I_C = 0$ )	7	V
۱ <sub>C</sub>	Collector current	30	4
I <sub>CM</sub>	Collector peak current (t <sub>p</sub> ≤5ms)	60	A
I <sub>CP</sub>	Collector peak current non repetitive ( $t_p \le 20 \ \mu s$ )	80	А
Ι <sub>Β</sub>	Base current	8	А
I <sub>BM</sub>	Base peak current ( $t_p \le 5ms$ )	30	А
P <sub>TOT</sub>	Total power dissipation at $T_c = 25 \text{ °C}$	250	W
T <sub>stg</sub>	Storage temperature	-65 to 200	°C
Τ <sub>J</sub>	Max. operating junction temperature	200	U

#### Table 3. Thermal data

Sym	bol Perometer	Value	Unit
R <sub>thj-c</sub>	Thermal resistance junction-case max.	0.7	°C/W
	du		
	PIC		
et <sup>e</sup>			
GOID			
005			



### **Electrical characteristics** 2

(T<sub>case</sub> = 25 °C; unless otherwise specified)

125 °C	50	400 4 1 8 2 2	μΑ mA μΑ μΑ mA
-04	50	8	μA mA
45	50		
45	50	2	mA
45	50		1
			v
= 2 mH 100	00		v
= 3.2 A I <sub>B</sub> = 5 A		1.5 5	V V
= 3.2 A		1.6	v
= 150 V A		1 3 0.8	μs μs μs
=	150 V	150 V	150 V 1 3

Table 4.	Electrical	characteristics



### **Electrical characteristics (curves)** 2.1

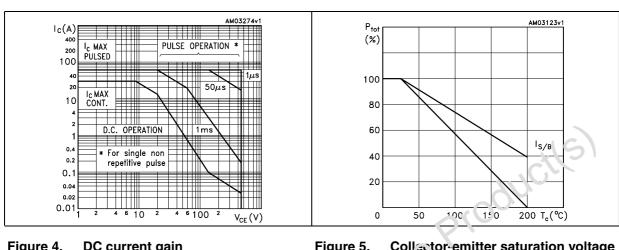
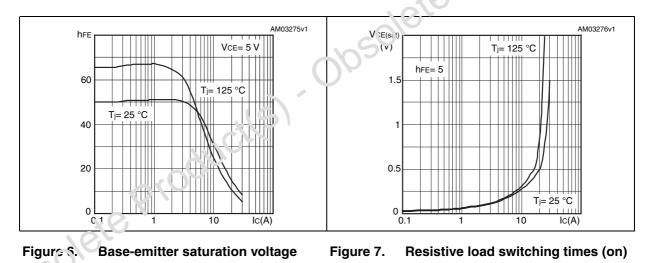


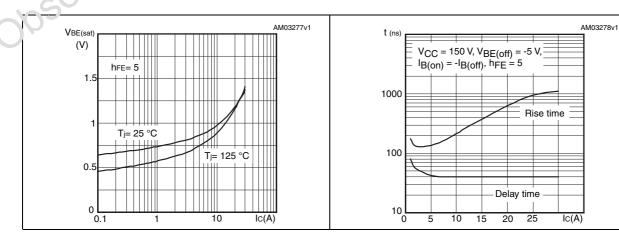
Figure 3.

### Figure 2. Safe operating area

Figure 4. DC current gain Figure 5. Collactor-emitter saturation voltage

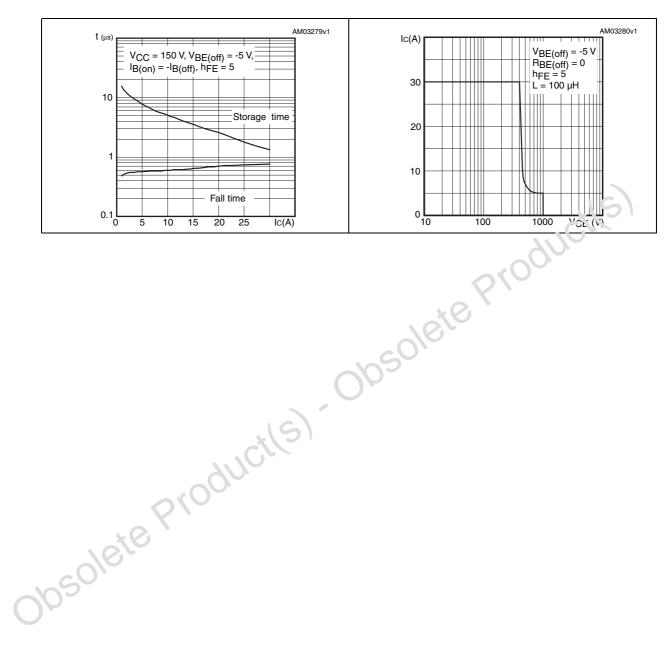
**Derating curve** 





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## Figure 8. Resistive load switching times (off) Figure 9. Reverse biased SOA





# 3 Test circuits

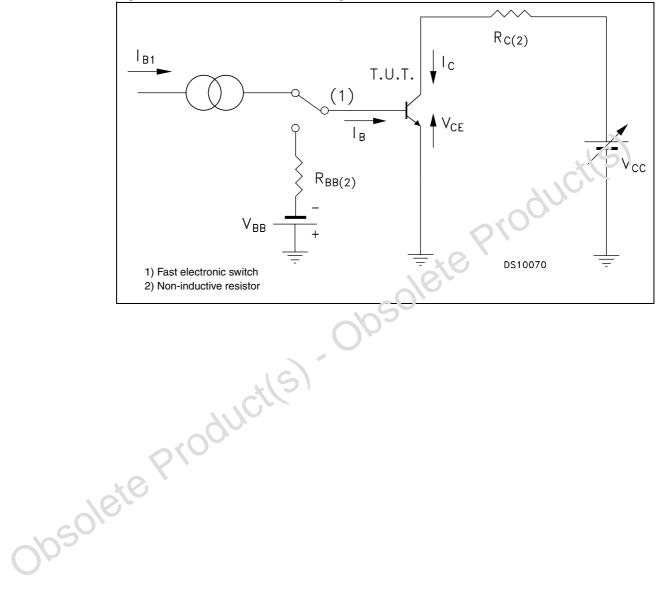


Figure 10. Resistive load switching test circuit



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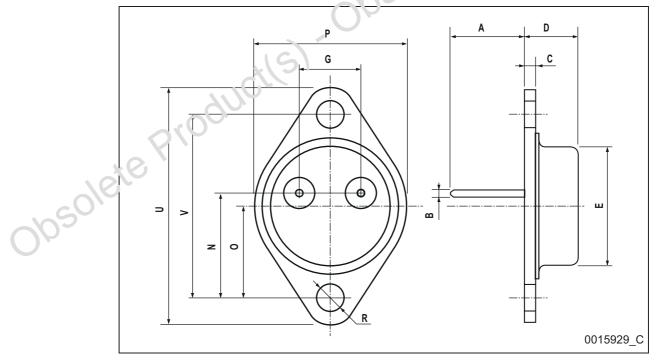
# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Obsolete Product(s). Obsolete Product(s)

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		TO-3 ty	ype R Mech	anical data	1	
DIM.		mm			inch	
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А		11.7			0.460	
В	0.96		1.10	0.037		0.043
С			1.70			0.066
D			8.7			0.342
E			20.0			rj.787
G		10.9			0.429	77
Ν		16.9			0.0:5	
Р			26.2	0	0	1.031
R	3.88		4.09	0 152		0.161
U			39.50	20		1.555
V		30.10	<u> </u>		1.185	





# 5 Revision history

Table 5.Document revision history

21-Jun-2004
24-Nov-2008
ePro

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